TOSHIBA Photocoupler GaAℓAs IRed & Photo−IC

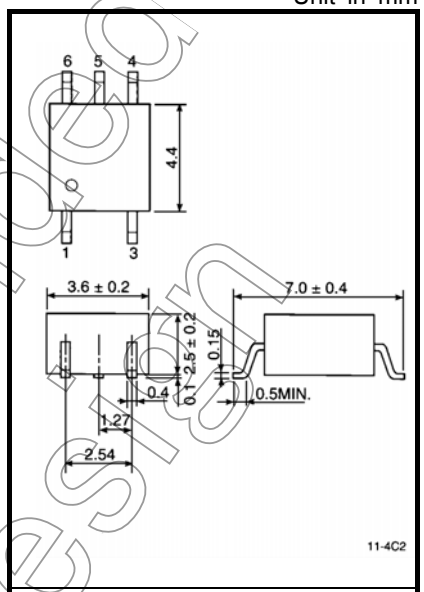
TLP113

Isolated Line Receiver
Simplex / Multiplex Data Transmission
Computer−Peripheral Interface
Microprocessor System Interface
Digital Isolation For A / D, D / A Conversion

The TOSHIBA mini flat coupler TLP113 is a small outline coupler, suitable for surface mount assembly.
TLP113 consists of a GaAℓAs light emitting diode, optically coupled to an integrated high gain, high speed photodetector whose output is an open collector, schottky clamped transistor.

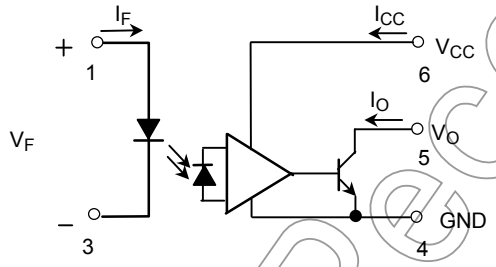
- Input current thresholds: I_F=10mA(max.)
- Switching speed: 10MBd(typ.)
- TTL / LSTTL compatible: V_{CC}=5V
- Guaranteed performance over temp.: 0~70°C
- Isolation voltage: 2500Vrms(min.)
- UL recognized: UL1577 file no. E67349

Unit in mm



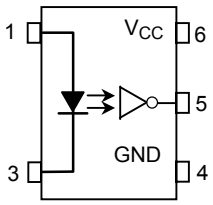
TOSHIBA 11−4C2
Weight: 0.09 g (typ.)

Schematic



(Note) A 0.1μF bypass capacitor must be connected between pins 4 and 6.

Pin Configuration(top view)



1 : Anode
3 : Cathode
4 : GND
5 : Output (Open collector)
6 : V_{CC}

TRUTH TABLE (Positive Logic)

INPUT	OUTPUT
H	L
L	H

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit
LED	Forward current		I_F	20	mA
	Pulse forward current	(Note 1)	I_{FP}	40	mA
	Peak transient forward current	(Note 2)	I_{FPT}	1	A
	Reverse voltage		V_R	5	V
Detector	Output current		I_O	25	mA
	Output voltage		V_O	7	V
	Supply voltage (1 minute maximum)		V_{CC}	7	V
	Output power dissipation		P_O	40	mW
Operating temperature range			T_{opr}	−40~85	°C
Storage temperature range			T_{stg}	−55~125	°C
Lead solder temperature (10s)			T_{sol}	260	°C
Isolation voltage (AC, 1 min., RH ≤ 60%,		Note 4)	BV_S	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) 50% duty cycle, 1ms pulse width.

(Note 2) Pulse width≤1μs, 300pps.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Input voltage, low level	V_{FL}	−3	0	1.0	V
Input current, high level	I_{FH}	13*	16	20	mA
Supply voltage**	V_{CC}	4.5	5	5.5	V
Fan out (TTL load, each channel)	N	—	—	8	—
Operating temperature	T_{opr}	0	—	70	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

* 13mA is a guard banded value which allows for at least 20% CTR degradation.

Initial input current threshold value is 10mA or less.

**This item denotes operating ranges, not meaning of recommended operating conditions.

Electrical Characteristics(unless otherwise specified, Ta=0~70°C, V_{CC}=4.5~5.5V, V_{FL}≤ 1.0V)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Forward voltage	V_F	I_F=10mA, Ta=25°C	—	1.65	1.80	V
Forward voltage temperature coefficient	V_F / Ta	I_F=10mA	—	−2	—	mV / °C
Reverse current	I_R	V_R=5V, Ta=25°C	—	—	10	μA
Capacitance between terminals	C_T	V_F=0, f=1MHz, Ta=25°C	—	45	—	pF
High level output current	I_{OH}	V_F=1.0, V_O=5.5V	—	—	250	μA
		V_F=1.0, V_O=5.5V, Ta=25°C	—	0.5	10	
Low level output voltage	V_{OL}	I_F=10mA I_{OL}=13mA(sinking)	—	0.4	0.6	V
"H level output→ L level output" input current	I_{FH}	I_{OL}=13mA(sinking) V_{OL}=0.6V	—	—	10	mA
High level supply current	I_{CCH}	V_{CC}=5.5V, I_F=0	—	7	15	mA
Low level supply current	I_{CCL}	V_{CC}=5.5V, I_F=16mA	—	12	18	mA
Input−output insulation leakage current	I_S	V_S=3540V, t=5s Ta=25°C (Note 4)	—	—	100	μA
Isolation resistance	R_S	R.H. ≤ 60%, V_S=500V DC Ta=25°C (Note 4)	5×10^{10}	10^{14}	—	Ω
Stray capacitance between input to output	C_S	V_S=0, f=1MHz Ta=25°C (Note 4)	—	0.8	—	pF

* All typical values are V_{CC}=5V, Ta=25°C

Switching Characteristics (V_{CC}=5V, Ta=25°C)

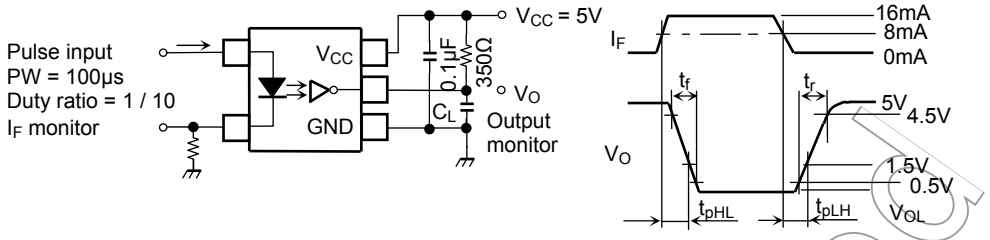
Characteristic	Symbol	Test Cir−cuit	Test Condition	Min.	Typ.	Max.	Unit
Propagation delay time (H→L)	t_pHL	1	I_F=0→16mA C_L=15pF, R_L=350Ω	—	60	120	ns
Propagation delay time (L→H)	t_pLH	1	I_F=16→0mA C_L=15pF, R_L=350Ω	—	60	120	ns
Output rise−fall time (10−90%)	t_r, t_f	2	R_L=350Ω, C_L=15pF I_F=0⇄16mA	—	30	—	ns
Common mode transient imunity at high output level	CM_H	2	I_F=0mA, V_{CM}=200V_{p-p} $V_{O(min)}$=2V, R_L=350Ω	—	200	—	V / μs
Common mode transient imunity at low output level	CM_L	2	I_F=16mA, V_{CM}=200V_{p-p} $V_{O(max)}$=0.8V, R_L=350Ω	—	−500	—	V / μs

(Note 4) Device considered a two−terminal device: Pins 1 and 3 shorted together, and pins 4, 5 and 6 shorted together.

(Note 5) The V_{CC} supply voltage to each TLP113 isolator must be bypassed by 0.1μF capacitor, this can be either a ceramic or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible to package V_{CC} and GND pins of each device.

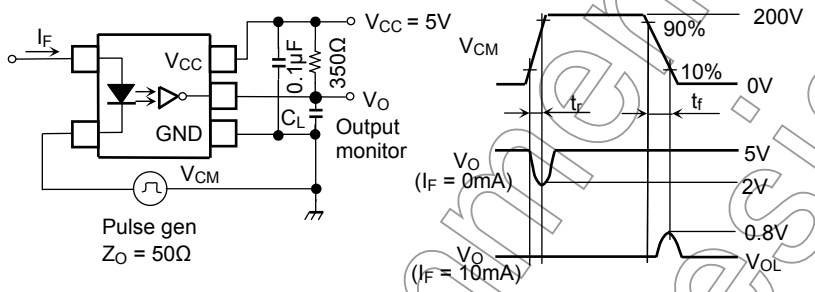
(Note 6) Maximum electrostatic discharge voltage for any pins: 180V(C=200pF, R=0)

Test Circuit 1: Switching Time Test Circuit



C_L is approximately 15pF which includes probe and stray wiring capacitance.

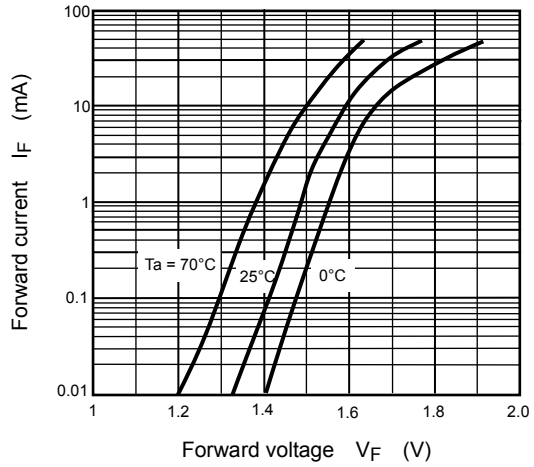
Test Circuit 2: Common Mode Transient Immunity Test Circuit



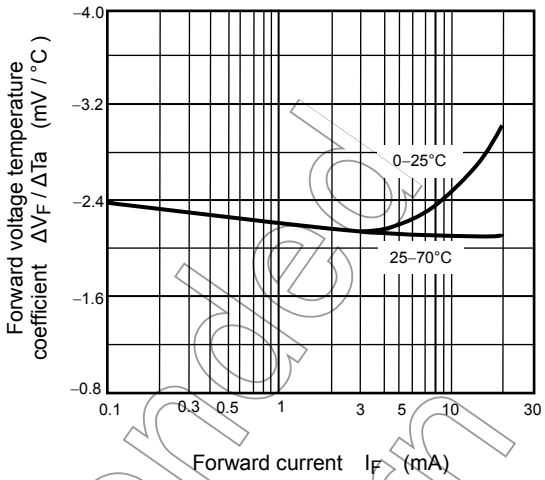
$$CM_H = \frac{160(V)}{t_r(\mu s)}, CM_L = \frac{160(V)}{t_f(\mu s)}$$

C_L is approximately 15pF which includes probe and stray wiring capacitance.

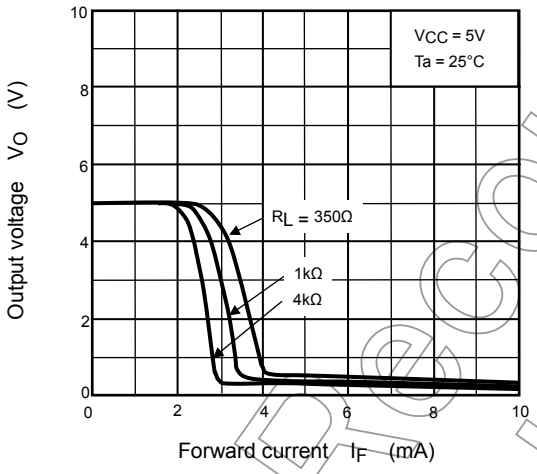
$I_F - V_F$



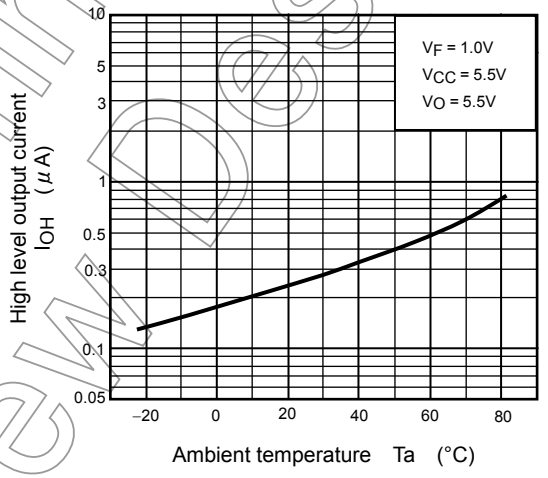
$\Delta V_F / \Delta Ta - I_F$



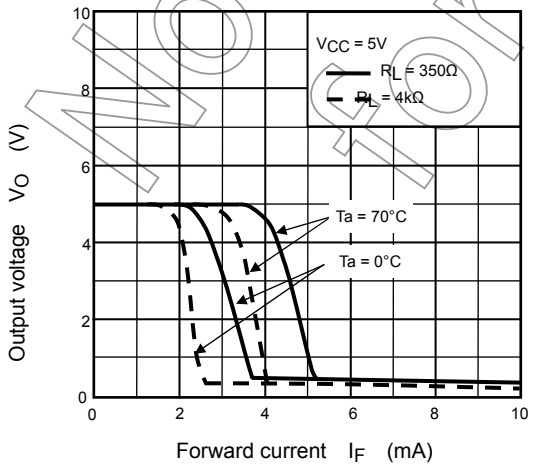
$V_O - I_F$



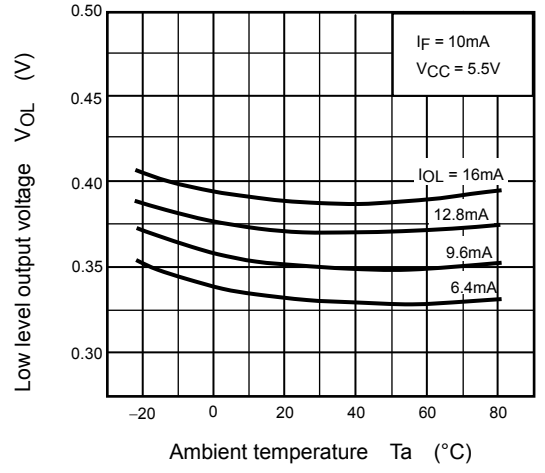
$I_{OH} - Ta$



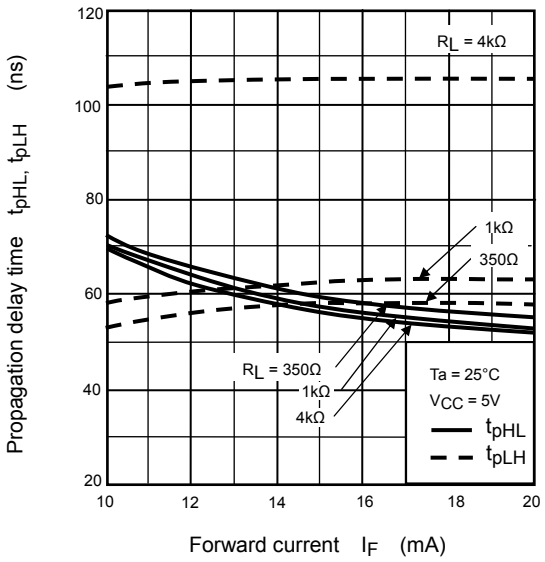
$V_O - I_F$



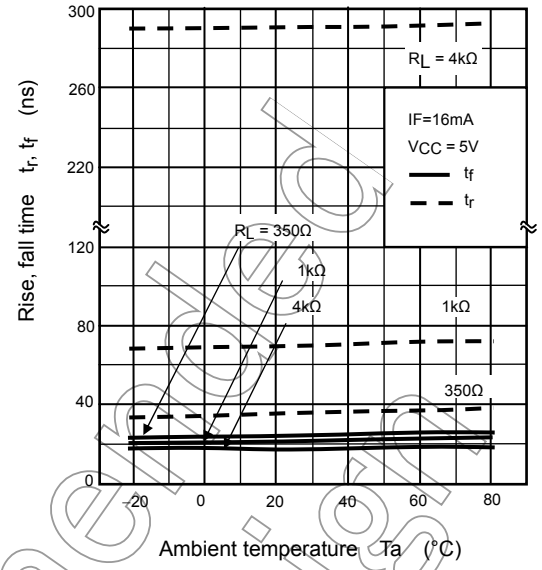
$V_{OL} - Ta$



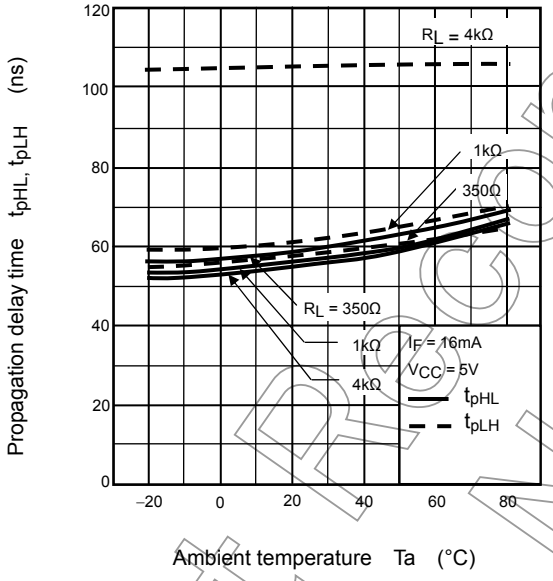
t_{pHL} , t_{pLH} – I_F



t_r, t_f – T_a



t_{pHL} , t_{pLH} – Ta



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